## (19) World Intellectual Property Organization

International Bureau



## 

(43) International Publication Date 6 January 2005 (06.01.2005)

PCT

(10) International Publication Number WO 2005/001492 A1

- G01R 31/307, (51) International Patent Classification7: H01L 21/66
- (21) International Application Number:

PCT/US2004/018159

(22) International Filing Date:

7 June 2004 (07.06.2004)

(25) Filing Language:

**English** 

(26) Publication Language:

English

(30) Priority Data: 60/477,611

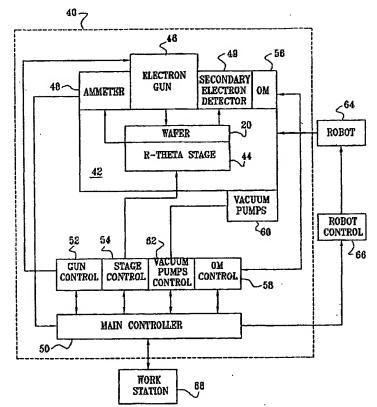
10 June 2003 (10.06.2003)

- (71) Applicant (for all designated States except US, ZW): AP-PLIED MATERIALS ISRAEL, LTD. [IL/IL]; 8 Opponheimer Street, 76236 Rehovot (IL).
- (71) Applicant (for ZW only): APPLIED MATERIALS, INC. [US/US]; P.O. Box 450A, Santa CLara, CA 95052 (US).

- (72) Inventors; and
- (75) Inventors/Applicants (for US only): KADYSHE-VITCH, Alexander [IL/IL]; 20/5 Eliyahu Hanavi St., 71700 Modiin (IL). SHUR, Dmitry [---/IL]; Holon (IL). TALBOT, Christopher [GB/US]; 6 Summit Court, Emerals Hills, CA 94062 (US).
- (74) Agent: FAHMI, Tarck; 12400 Wilshire Boulevard, 7th Floor, Los Angeles, CA 90025 (US).
- (81) Designated States (unless otherwise indicated, for every kind of national protection available): AE, AG, AL, AM, AT, AU, AZ, BA, BB, BG, BR, BW, BY, BZ, CA, CH, CN, CO, CR, CU, CZ, DE, DK, DM, DZ, EC, EE, EG, ES, FI, GB, GD, GE, GH, GM, HR, HU, ID, IL, IN, IS, JP, KE, KG, KP, KR, KZ, LC, LK, LR, LS, LT, LU, LV, MA, MD, MG, MK, MN, MW, MX, MZ, NA, NI, NO, NZ, OM, PG, PH, PL, PT, RO, RU, SC, SD, SE, SG, SK, SL, SY, TJ, TM, TN, TR, TT, TZ, UA, UG, US, UZ, VC, VN, YU, ZA, ZM, ZW.

[Continued on next page]

(54) Title: HIGH CURRENT ELECTRON BEAM INSPECTION



(57) Abstract: A method and apparatus for wafer inspection. The apparatus is capable of testing a sample having a first layer that is at least partly conductive and a second, dielectric layer formed over the first layer, following production of contact openings in the second layer, the apparatus includes: (i) an electron beam source adapted to direct a high current beam of charged particles to simultaneously irradiate a large number of contact openings at multiple locations distributed over an area of the sample; (ii) a current measuring device adapted to measure a specimen current flowing through the first layer in response to irradiation of the large number of contact openings at the multiple locations; and (iii) a controller adapted to provide an indication of the at least defective hole in response to the measurement.

O 2005/001492 A1

- (84) Designated States (unless otherwise indicated, for every kind of regional protection available): ARIPO (BW, GH, GM, KE, LS, MW, MZ, NA, SD, SL, SZ, TZ, UG, ZM, ZW), Eurasian (AM, AZ, BY, KG, KZ, MD, RU, TJ, TM), European (AT, BE, BG, CH, CY, CZ, DE, DK, EE, ES, FI, FR, GB, GR, HU, IE, IT, LU, MC, NL, PL, PT, RO, SE, SI, SK, TR). OAPI (BF, BJ, CF, CG, CI, CM, GA, GN, GQ, GW, ML, MR, NE, SN, TD, TG).
- before the expiration of the time limit for amending the claims and to be republished in the event of receipt of amendments

For two-letter codes and other abbreviations, refer to the "Guidance Notes on Codes and Abbreviations" appearing at the beginning of each regular issue of the PCT Gazette.

## Published:

with international search report

**JEST AVAILABLE COPY**